

# LM5122EVM-2PH Evaluation Module

## User's Guide



Literature Number: SNVU205  
APRIL 2013

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## **LM5122EVM-2PH Evaluation Module**

### **1 Introduction**

The LM5122EVM-2PH evaluation module (EVM) provides the design engineer with a fully functional dual phase synchronous boost converter to evaluate the Texas Instruments LM5122 synchronous boost controller device. The EVM provides 28 V output at up to 7 A current from a 9 V to 20 V input. The EVM is designed to start up from a single power supply without any additional bias voltage.

### **2 Features and Electrical Performance**

- 9 V to 20 V input voltage range
- 28 V target output voltage
- Up to 7 A output current
- 250 kHz typical switching frequency
- Dual phase interleaved operation

**Table 1. Electrical Performance Specifications**

| PARAMETER                     | TEST CONDITIONS   | MIN   | TYP | MAX   | UNITS |
|-------------------------------|---|-------|-----|-------|-------|
| <b>Input Characteristics</b>  |   |       |     |       |       |
| Input Voltage                 |   | 9     | 12  | 20    | V     |
| Input Current                 | $V_{\text{SUPPLY}} = 12 \text{ V}, I_{\text{LOAD}} = 7 \text{ A}$ |       | 17  |       | A     |
| <b>Output Characteristics</b> |   |       |     |       |       |
| Output Voltage                | $I_{\text{LOAD}} = 7 \text{ A}$                                   | 27.02 | 28  | 28.98 | V     |
| Output Current                |   |       |     | 7     | A     |
| <b>System Characteristics</b> |   |       |     |       |       |
| Switching Frequency           |   |       | 250 |       | kHz   |
| Full Load Efficiency          | $V_{\text{SUPPLY}} = 12 \text{ V}$                                |       | 96% |       |       |
|                               | $V_{\text{SUPPLY}} = 20 \text{ V}$                                |       | 98% |       |       |

### **3 Test Points**

#### **3.1 Test Points**

**Table 2. Pin Descriptions**

| PIN NAME       | DESCRIPTIONS                                  |
|----------------|---|
| TP7, TP8       | Power Ground                                  |
| TP5, TP9, TP10 | Analog Ground                                 |
| TP6            | UVLO  |
| J1#1           | External Synchronization Pulse Positive Input |
| J1#2           | External Synchronization Pulse Negative Input |

## 4 Test Equipment

### 4.1 Power Supply

Power Supply should be capable of 20 V / 25 A, current monitoring and remote sensing.

### 4.2 Electronic Load

Electronic load should be capable of 32 V / 7 A. Use Constant Current (CC) mode.

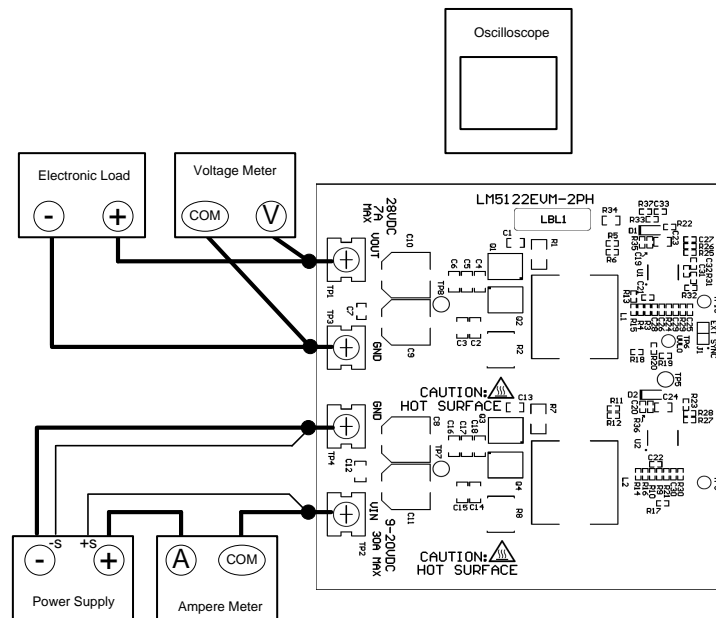
### 4.3 Meters

One current meter is required to measure input current accurately. Maximum current rating of the meter should be carefully considered. Input current can be as high as 25 A at full load current and minimum input voltage. Output voltage is monitored by a voltage meter which should be capable of monitoring up to 32 V.

### 4.4 Oscilloscope

Oscilloscope and 10x probe with at least 20 MHz bandwidth are required.

## 5 Test Setup and Procedure



**Figure 1. Connection Diagram**

### 5.1 Precaution & Wire Gauge

Prolonged operation with low input voltage at full power will cause heating of the MOSFETs. A fan with a minimum of 200LFM should be always provided.

Wire gauge for the input power supply should be 6-8 AWG minimum and no longer than 1 foot each for VIN and GND. Wire gauge for the output electronic load should be 12 AWG minimum and no longer than 1 foot each for VOUT and GND.

## 5.2 Test Setup

### 5.2.1 Power Supply

Connect the power supply's positive terminal (+) to 'A' terminal of ampere meter and negative terminal (-) to TP4 GND. Connect the power supply's positive remote sense terminal to TP2 VIN and negative remote sense terminal to TP4 GND.

### 5.2.2 Meter

Connect 'COM' terminal of ampere meter to TP2 VIN. Double check 'A' terminal is connected to the power supply's positive terminal.

Voltage meter is used to measure output voltage. Connect positive terminal (V) of the voltage meter to TP1 VOUT and negative terminal (COM) of the voltage meter to TP3 GND.

### 5.2.3 Load

Connect electronic load's positive terminal (+) to TP1 VOUT and negative terminal (-) to TP3 GND.

## 5.3 Quick Test Procedure

### 5.3.1 Startup

- Set load current to 0 A and turn the load on
- Set power supply current limit to 25 A
- Turn on the power supply and increase voltage slowly up to 20 V
- Increase load current slowly up to 7 A

### 5.3.2 Shutdown

- Turn off the load
- Decrease the input voltage down to 0 V
- Turn on the load and discharge output capacitor

## 6 Performance Curves

The following curves are presented for reference, the actual field data may differ from these curves. Actual performance data can be affected by measurement techniques, equipment setting and environmental variables.

### 6.1 Efficiency

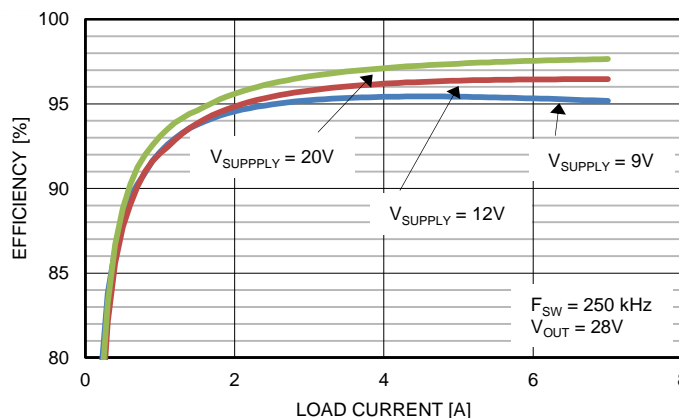


Figure 2. Efficiency

### 6.2 Load Transient

$V_{\text{SUPPLY}} = 12 \text{ V}$ , 3.5 A to 7 A and 7 A to 3.5 A load transient

C1:  $V_{\text{OUT}}$

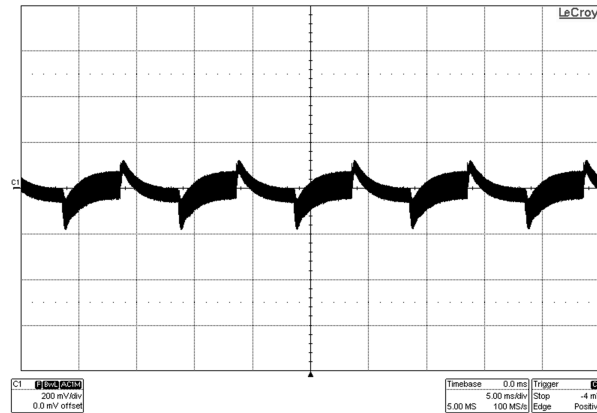


Figure 3. Load Transient

### 6.3 Interleaving

$V_{\text{SUPPLY}} = 12 \text{ V}$

C1: SW1, C2: SW2

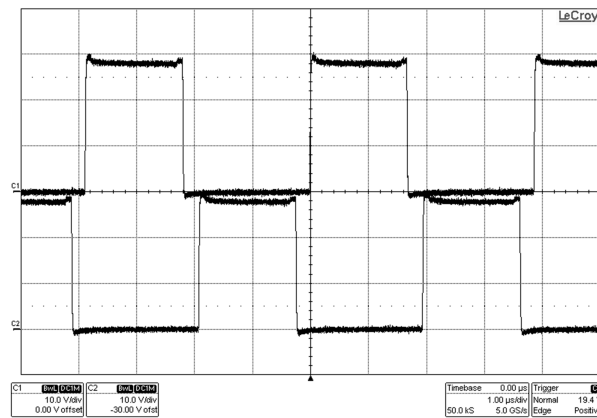


Figure 4. Interleaving

### 6.4 Light Load Operations

Forced PWM (FPWM) and Skip Cycle mode can be configured by controlling MODE pin voltage.

$$V_{\text{SUPPLY}} = 12 \text{ V}, I_{\text{LOAD}} = 0 \text{ A}$$

C1:SW1

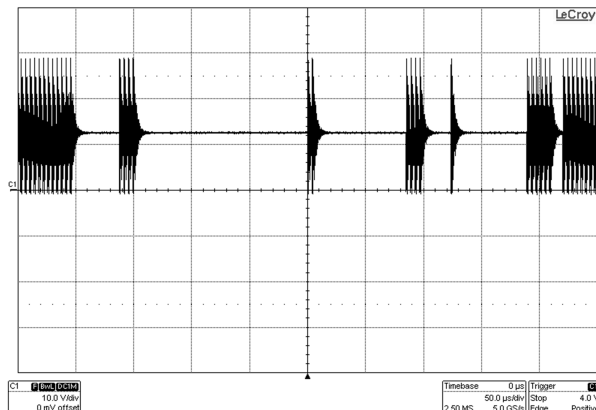


Figure 5. Pulse Skip

C1: SW1

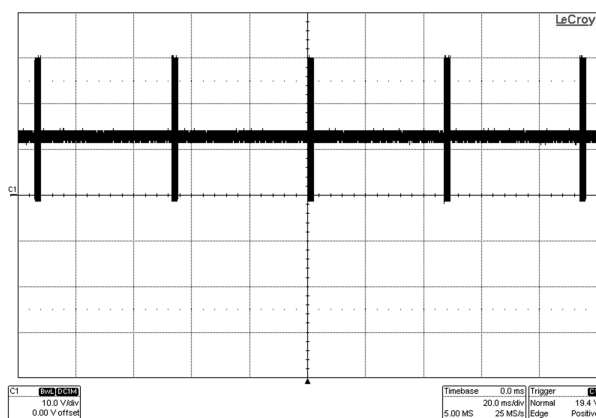


Figure 6. Skip Cycle

C1: SW1

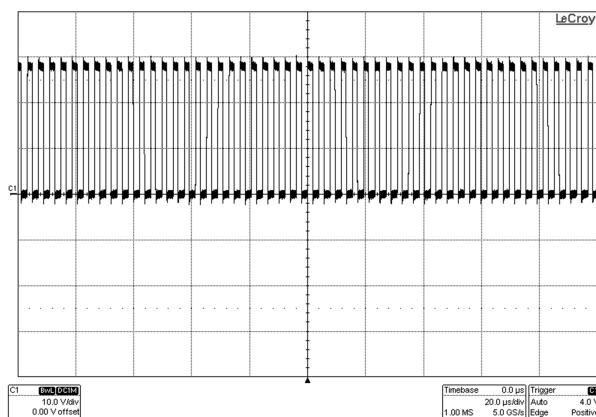


Figure 7. Forced PWM



### 6.5 Startup

$V_{\text{SUPPLY}} = 12 \text{ V}$ ,  $I_{\text{LOAD}} = 0 \text{ A}$

C1:  $V_{\text{OUT}}$ , C2: SS, C4:  $V_{\text{SUPPLY}}$

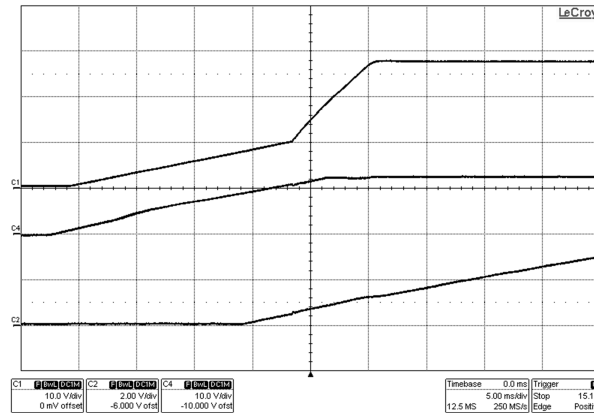


Figure 8. Startup

### 6.6 Loop Response

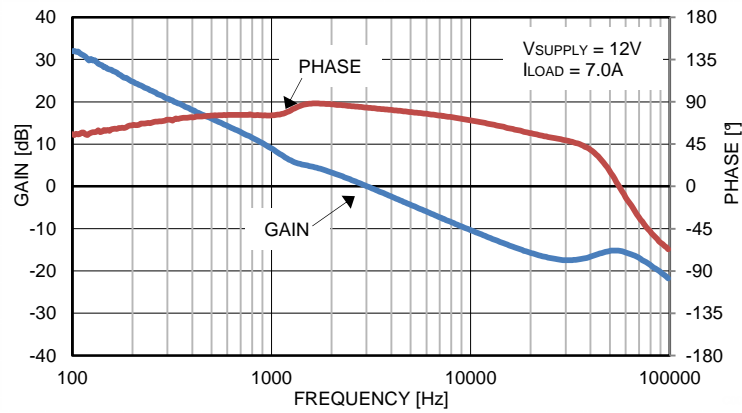


Figure 9. Loop Response

7 Schematic

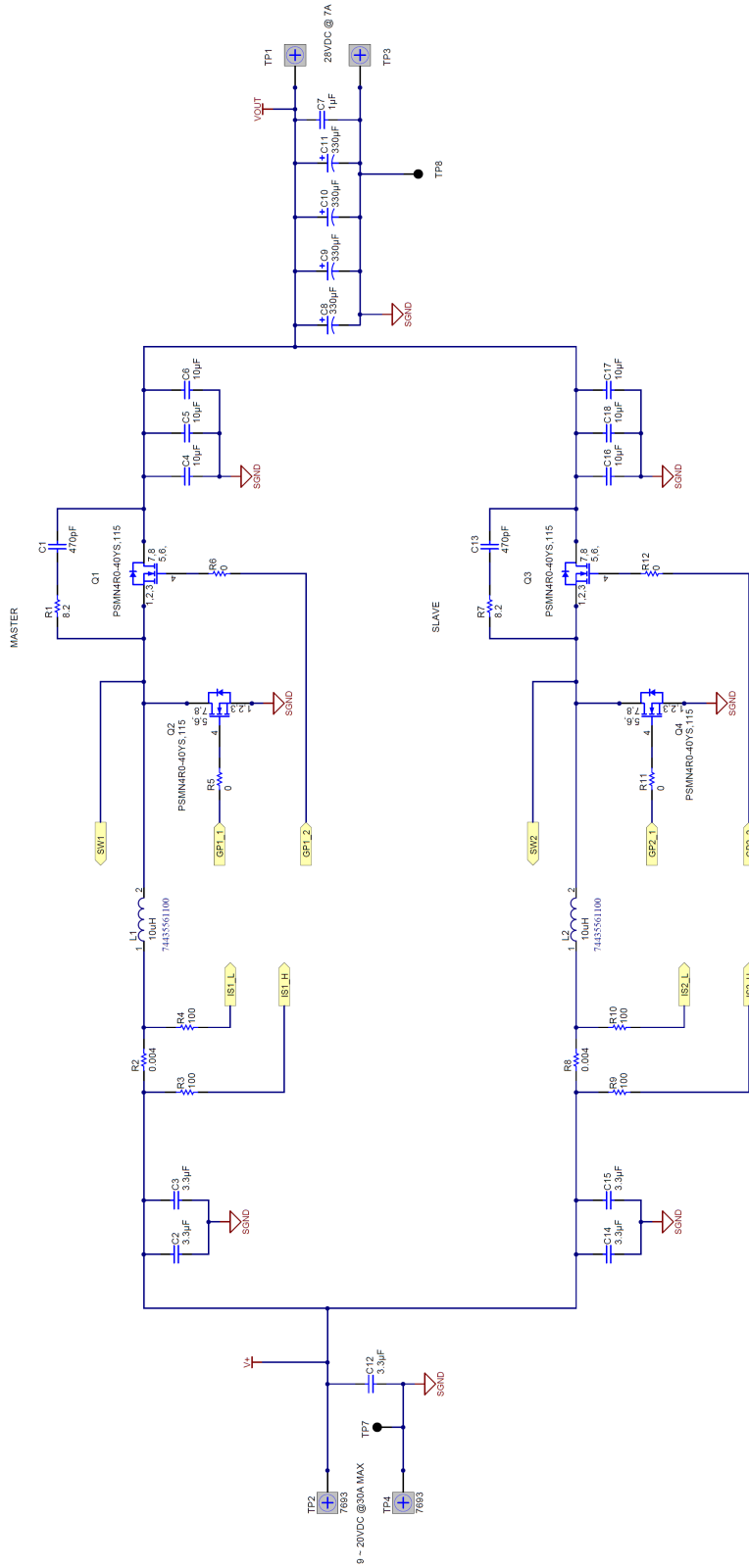


Figure 10. Schematic (Power Block)

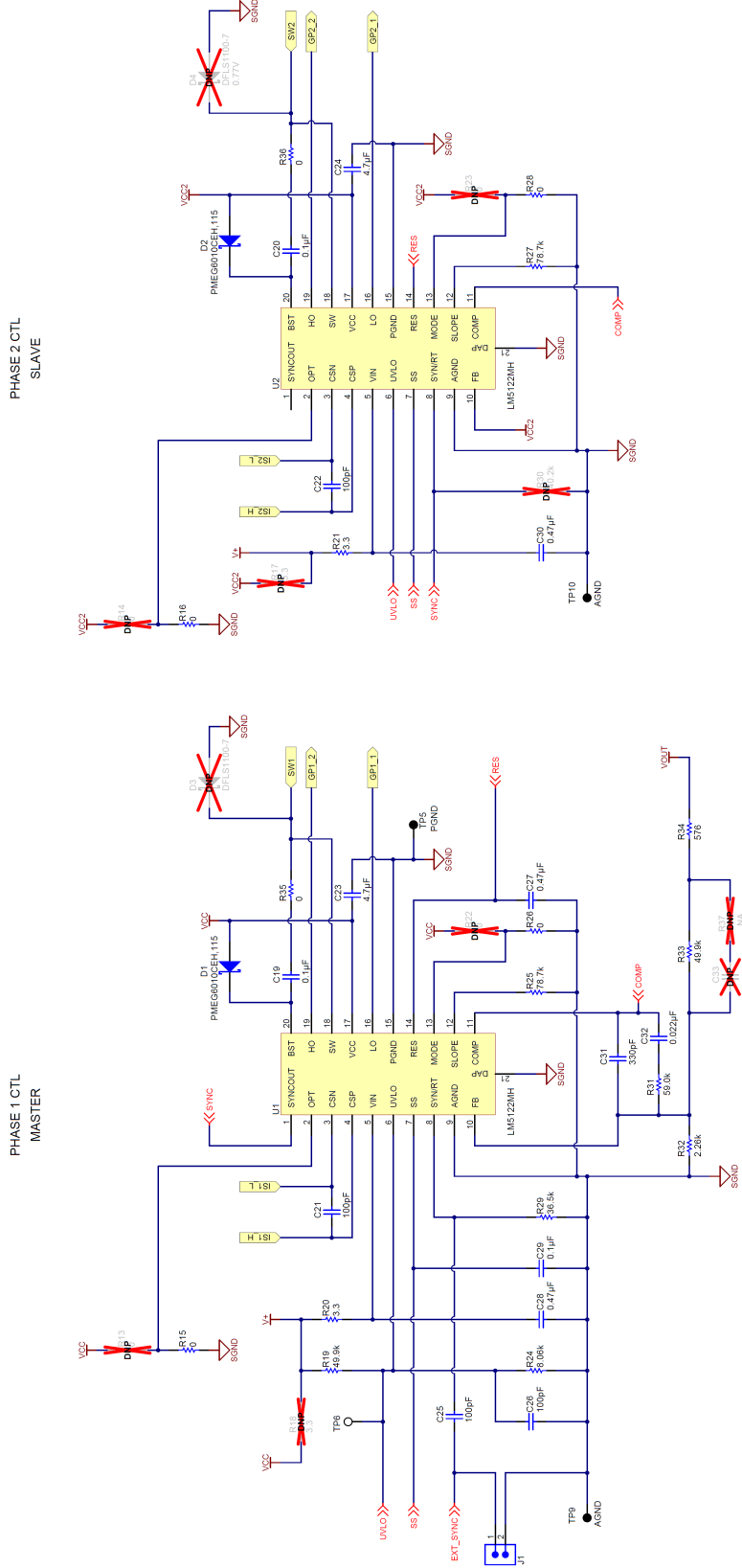


Figure 11. Schematic (Control Block)

## 8 Layout

The LM5122 2-phase EVM has been designed using a 4-layer board. Most of components are on the top to allow the user to easily view, probe, and evaluate the LM5122 device.

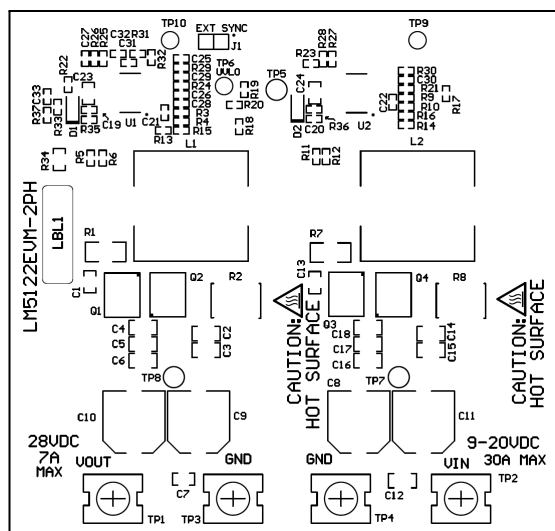


Figure 12. Top Silk (Top View)

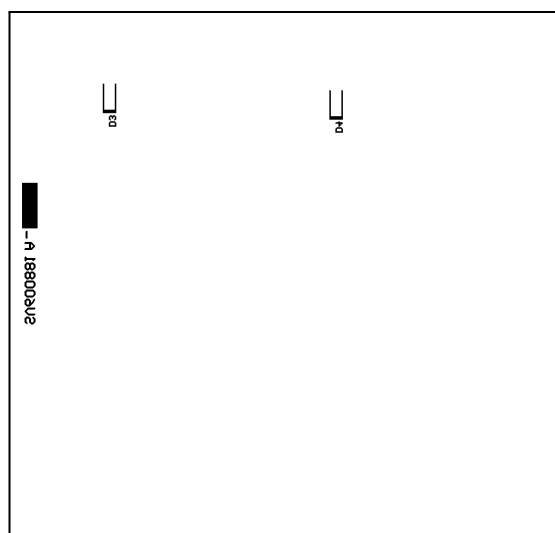


Figure 13. Bottom Silk (X-Ray View)

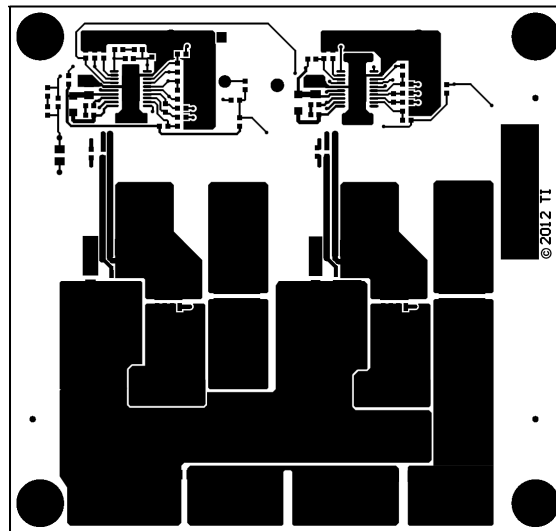


Figure 14. Top Copper (Top View)

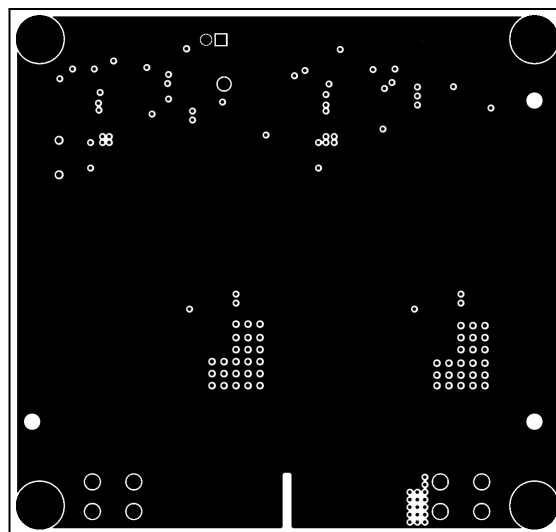
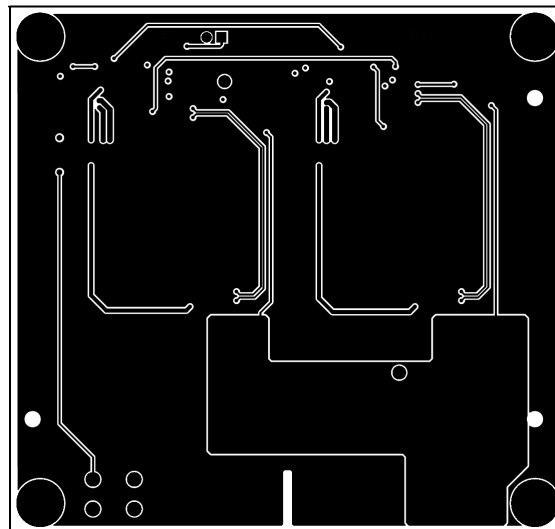
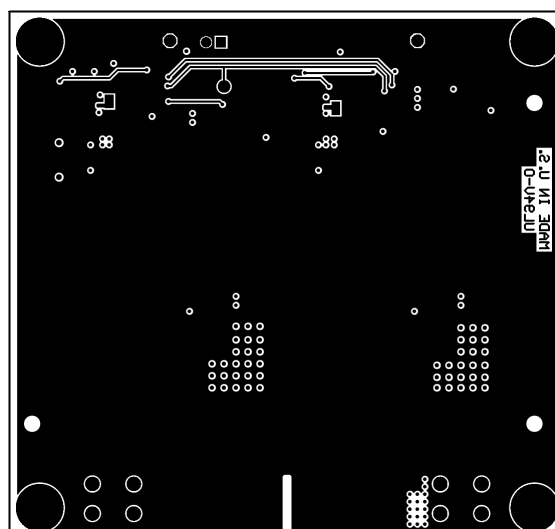


Figure 15. Mid1 Copper (X-Ray View)



**Figure 16. Mid2 Copper (X-Ray View)**



**Figure 17. Bottom Copper (X-Ray View)**

## 9 Bill of Materials

The EVM components are list according to the schematic shown in [Figure 10](#) and [Figure 11](#) .

**Table 3. Bill of Materials**

| REFERENCE DESIGNATOR                           | DESCRIPTION                                  | MANUFACTURER      | PART NUMBER         | QTY |
|--|--|-------------------|---------------------|-----|
| C1, C13  | CAP, CER, 470 pF, 100 V, +/-5%, C0G, 0805    | MURATA            | GRM2165C2A471JA01D  | 2   |
| C2, C3, C12, C14, C15                          | CAP CER 3.3 uF 50 V 10% X7R 1206             | TDK               | C3216X7R1H335K160AC | 5   |
| C4, C5, C6, C16, C17, C18                      | CAP CER 10 uF 35 V 10% X7R 1206              | Taiyo Yuden       | GMK316AB7106KL      | 6   |
| C7   | CAP, CER, 1 uF, 50 V, +/-10%, X7R, 0805      | MURATA            | GRM21BR71H105KA12L  | 1   |
| C8, C9, C10, C11                               | CAP ALUM 330 uF 35 V 20% SMD                 | Panasonic         | EEE-FP1V331AP       | 4   |
| C19, C20, C29                                  | CAP, CER, 0.1 uF, 25 V, +/-10%, X7R, 0603    | MURATA            | GRM188R71E104KA01D  | 3   |
| C21, C22, C25, C26                             | CAP, CER, 100 pF, 50 V, +/-5%, C0G/NP0, 0603 | MURATA            | GRM1885C1H101JA01D  | 4   |
| C23, C24                                       | CAP, CER, 4.7 uF, 16 V, +/-10%, X7R, 0805    | MURATA            | GRM21BR71C475KA73L  | 2   |
| C27, C28, C30                                  | CAP, CER, 0.47 uF, 25 V, +/-10%, X7R, 0603   | MURATA            | GRM188R71E474KA12D  | 3   |
| C31  | CAP, CER, 330 pF, 50 V, +/-10%, X7R, 0603    | KEMET             | C0603C331K5RACTU    | 1   |
| C32  | CAP, CER, 0.022 uF, 50 V, +/-10%, X7R, 0603  | KEMET             | C0603C223K5RACTU    | 1   |
| R1, R7   | RES 8.2 Ω 3/4W 5% 2010 SMD                   | Vishay            | CRCW20108R20JNEF    | 2   |
| R2, R8   | RES, 0.004 Ω, 3 W, 1%, 3015, WIDE            | Susumu            | KRL7638-C-R004-F-T1 | 2   |
| R3, R4, R9, R10                                | RES, 100 Ω, 1%, 0.1 W, 0603                  | Vishay            | CRCW0603100RFKEA    | 4   |
| R5, R6, R11, R12, R15, R16, R26, R28, R35, R36 | RES, 0 Ω, 5%, 0.1 W, 0603                    | Panasonic         | ERJ-3GEY0R00V       | 10  |
| R19, R33                                       | RES, 49.9k Ω, 1%, 0.1 W, 0603                | Vishay            | CRCW060349K9FKEA    | 2   |
| R20, R21                                       | RES, 3.3 Ω, 5%, 0.1 W, 0603                  | Vishay            | CRCW06033R30JNEA    | 2   |
| R24  | RES, 8.06k Ω, 1%, 0.1 W, 0603                | Vishay            | CRCW06038K06FKEA    | 1   |
| R25, R27                                       | RES, 78.7k Ω, 1%, 0.1 W, 0603                | Vishay            | CRCW060378K7FKEA    | 2   |
| R29  | RES, 36.5k Ω, 1%, 0.1 W, 0603                | Vishay            | CRCW060336K5FKEA    | 1   |
| R31  | RES, 59.0k Ω, 1%, 0.1 W, 0603                | Vishay            | CRCW060359K0FKEA    | 1   |
| R32  | RES, 2.26k Ω, 1%, 0.1 W, 0603                | Vishay            | CRCW06032K26FKEA    | 1   |
| R34  | RES, 576 Ω, 1%, 0.125 W, 0805                | Vishay            | CRCW0805576RFKEA    | 1   |
| D1, D2   | Diode, Schottky, 60 V, 1 A, SOD-123F         | NXP               | PMEG6010CEH         | 2   |
| Q1, Q2, Q3, Q4                                 | MOSFET N-CH 40 V 100 A LPAK                  | NXP               | PSMN4R0-40YS        | 4   |
|  | MOSFET N-CH 40 V 100 A SON 5x6               | Texas Instruments | CSD18501Q5A         | ALT |
| L1, L2   | SMD Flat Wire WE-HCI, L Ω = 10.0 μH          | WURTH             | 74435561100         | 2   |
| TP1, TP2, TP3, TP4                             | Terminal screw, vertical, snap-in            | Keystone          | 7693                | 4   |
| TP5, TP7, TP8                                  | Test Point, TH, Multipurpose, Black          | Keystone          | 5011                | 3   |
| TP6  | Test Point, TH, Miniature, White             | Keystone          | 5002                | 1   |
| TP9, TP10                                      | Test Point, TH, Miniature, Black             | Keystone          | 5001                | 2   |
| H1, H2, H5, H6                                 | Standoff, Hex, 0.5"L #4-40 Nylon             | Keystone          | 1902C               | 4   |
| H3, H4, H7, H8                                 | Machine Screw, Round, #4-40 x 1/4, Nylon     | B&F               | NY PMS 440 0025 PH  | 4   |
| J1   | Header, TH, 100mil, 2x1, Gold plated         | SAMTEC            | TSW-102-07-G-S      | 1   |
| U1, U2   | Synchronous Boost Controller                 | Texas Instruments | LM5122MH            | 2   |





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